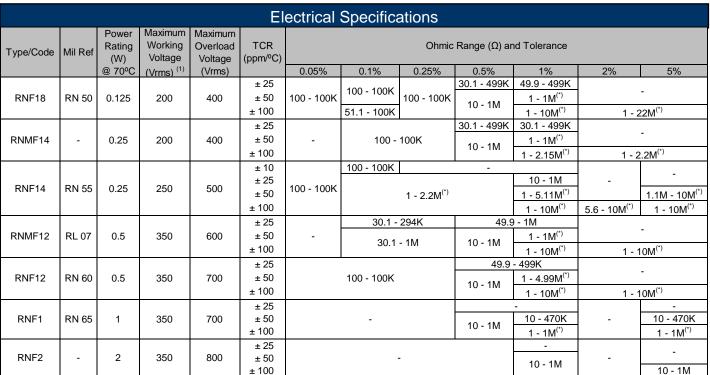
Stackpole Electronics, Inc.

General Purpose Metal Film Resistor Resistive Product Solution

Features:

- · Precision metal film
- Superior electrical, TCR performances
- Flame-retardant coatings are standard
- Panasert available selected sizes (contact Stackpole)
- RNMF (mini) an ideal choice where size constraints apply
- RNF 5% replaces MP series
- Lower or higher resistance values may be possible (contact Stackpole)
- 100% RoHS compliant and lead free without exemption
- REACH compliant and halogen free



⁽¹⁾ Lesser of √P*R or maximum working voltage

Mechanical Specifications

Type/Code	A	В	С	D	Unit
	Body Length	Body Diameter	Lead Length (Bulk)	Lead Diameter	Offic
RNF18	0.130 ± 0.012	0.071 ± 0.012	1.102 ± 0.118	0.018 ± 0.003	inches
KINF 10	3.30 ± 0.30	1.80 ± 0.30	28.00 ± 3.00	0.45 ± 0.07	mm
RNMF14	0.130 ± 0.012	0.070 ± 0.003	1.102 ± 0.118	0.017 ± 0.002	inches
	3.30 ± 0.30	1.78 ± 0.08	28.00 ± 3.00	0.44 ± 0.05	mm
RNF14	0.250 ± 0.026	0.093 ± 0.010	1.102 ± 0.118	0.022 ± 0.003	inches
	6.35 ± 0.65	2.35 ± 0.25	28.00 ± 3.00	0.56 ± 0.08	mm
RNMF12	0.250 ± 0.026	0.093 ± 0.010	1.102 ± 0.118	0.022 ± 0.003	inches
	6.35 ± 0.65	2.35 ± 0.25	28.00 ± 3.00	0.56 ± 0.08	mm
RNF12	0.344 ± 0.030	0.108 ± 0.039	1.102 ± 0.197	0.026 ± 0.004	inches
	8.75 ± 0.75	2.75 ± 1.00	28.00 ± 5.00	0.65 ± 0.10	mm

Rev Date: 3/30/2023

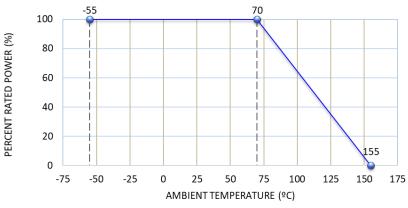
^(*) Contact Stackpole for resistance values below 10 ohms and above 1M

Mechanical Specifications (cont.)								
Type/Code	Α	В	С	D	Unit			
	Body Length	Body Diameter	Lead Length (Bulk)	Lead Diameter	Offic			
RNF1 (< 10Ω)	0.453 ± 0.039	0.177 ± 0.020	1.378 ± 0.079	0.031 ± 0.001	inches			
	11.50 ± 1.00	4.50 ± 0.50	35.00 ± 2.00	0.78 ± 0.03	mm			
RNF1 (≥ 10Ω)	0.433 ± 0.039	0.177 ± 0.020	1.181 ± 0.118	0.030 ± 0.002	inches			
	11.00 ± 1.00	4.50 ± 0.50	30.00 ± 3.00	0.75 ± 0.05	mm			
RNF2	0.591 ± 0.039	0.197 ± 0.020	1.339 ± 0.157	0.028 ± 0.004	inches			
	15.00 ± 1.00	5.00 ± 0.50	34.00 ± 4.00	0.70 ± 0.10	mm			

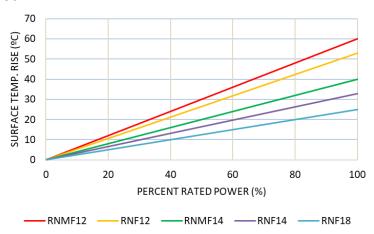
Performance Characteristics						
Test	Test Method	Typical Results	Test Limits			
Insulation Resistance	JIS C5201-1, IEC60115-1, 4.6	≥ 1000M Ω	≥ 1000M Ω			
Voltage Proof / DWV		RNF16 / RNMF14: 300 RNF14 / RNMF12: 500 RNF12 / RNF1: 700	≤ ± (0.5% + 0.05Ω) No mechanical damage			
Short Time Overload	JIS C5201-1, IEC60115-1, 4.13	< ± 0.1%	$\leq \pm (0.25\% + 0.05\Omega)$			
Resistance to Solder Heat	JIS C5201-1, IEC60115-1, 4.18	< ± 0.1%	$\leq \pm (0.3\% + 0.05\Omega)$			
Rapid Change of Temperature	JIS C5201-1, IEC60115-1, 4.19	< ± 0.05%	$\leq \pm (0.35\% + 0.05\Omega)$			
Endurance at 70°C	JIS C5201-1, IEC60115-1, 4.25.1	< ± 0.15%	≤± (1.0% + 0.05Ω)			
Robustness of Terminations	JIS C5201-1, IEC60115-1, 4.16	< ± 0.10%	$\leq \pm (0.2\% + 0.05\Omega)$			
Damp Heat (Steady state)	JIS C5201-1, IEC60115-1, 4.24	< ± 0.10%	$\leq \pm (1.5\% + 0.05\Omega)$			

Operating temperature range is -55°C to +155°C

Power Derating Curve:



Surface Temperature Rise:



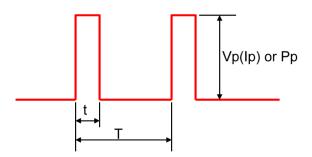
Repetitive Pulse Information:

If repetitive pulses are applied to resistors, pulse wave form must be less than "pulse limiting voltage", "pulse limiting current" or "pulse limiting wattage" calculated by the formula below.

$$Vp = K\sqrt{P \times R \times T/t}$$

$$Ip = K\sqrt{P/R \times T/t}$$

$$Pp = K^2 \times P \times T/t$$



Where: Vp: Pulse limiting voltage (V)

Ip: Pulse limiting current (A)Pp: Pulse limiting wattage (W)

P: Power rating (W)

R: Nominal resistance (ohm)
T: Repetitive period (sec)
t: Pulse duration (sec)

K: RNF / RNMF Coefficient: 0.7

[Vr: Rated Voltage (V), Ir: Rated Current (A)]

Note 1: If T > 10 \rightarrow T = 10 (sec), T / t > 1000 \rightarrow T / t = 1000

Note 2: If T > 10 and T / t > 1000, "Pulse Limiting power (Single pulse) is applied

Note 3: If Vp < Vr (lp < lr or Pp < P), Vr (lr, P) is Vp (lp, Pp)

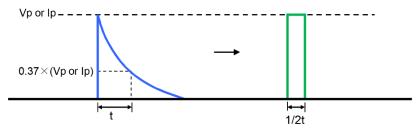
Note 4: Pulse limiting voltage (current, wattage) is applied at less than rated ambient temperature. If ambient temperature is more than the rated temperature (70 °C), decrease power rating according to "Power Derating Curve"

Note 5: Assure sufficient margin for use period and conditions for "pulse limiting voltage"

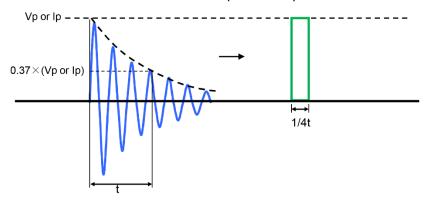
Note 6: If the pulse waveform is not square wave, judge after transform the waveform into square wave according to the "Waveform Transformation to Square Wave".

Waveform Transformation to Square Wave

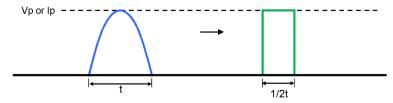
1. Discharge curve wave with time constant "t" → Square wave



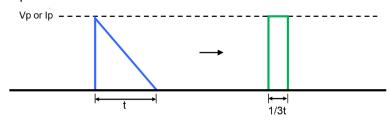
2. Damping oscillation wave with time constant of envelope "t" → Square wave



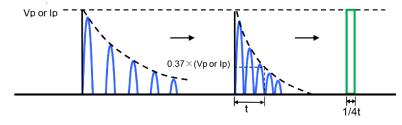
3. Half-wave rectification wave → Square wave



4. Triangular wave → Square wave



5. Special wave → Square wave



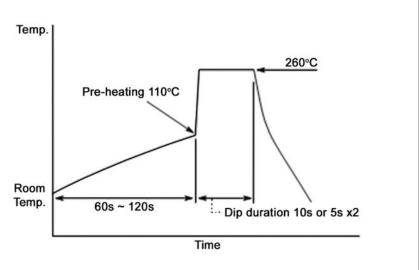
Recommended Soldering Condition

Flow Soldering:

- Pre-heating: 110°C MAX
- Peak temperature/duration: 260°C
 within 10 seconds (1st, 2nd wave total)
- Temperature profile (see chart on the right)

Iron Soldering:

- 380°C, 5 seconds, once/terminal



Points are cut at dotted line for 10° (25mm) reel only

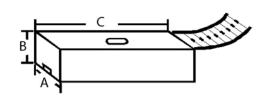
Series	A max ^{· (1)}	B max	С	D ⁽²⁾	Tape	Unit
RNF18	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
KINITIO	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm
RNMF14	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
KINIVII 14	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm
RNF14	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
KINF 14	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm
RNMF12	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
KINIVIF 12	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm
RNF12	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
KINITIZ	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm
RNF1	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
IXINITI	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm
RNF2	2.756 ± 0.118	11.811 ± 0.197	0.197 ± 0.020	2.047 ± 0.020	0.250	inches
KINFZ	70.00 ± 3.00	300.00 ± 5.00	5.00 ± 0.50	52.00 ± 0.50	6.35	mm

Dimension "E": This is a non-critical dimension that does not have a tolerance in the standard.

Range of diameters is from 0.547 inches (13.90 mm) to 1.500 inches (38.10 mm).

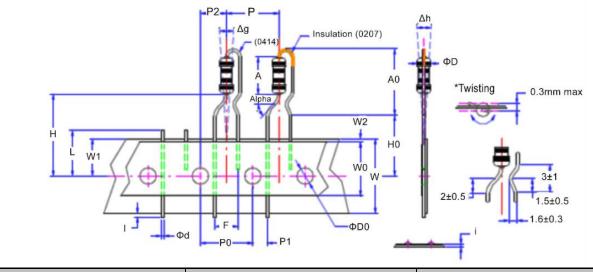
- (1) Reference value only. The "A" dimension shall be governed by the overall length of the taped component. The distance between flanges shall be 0.059 inches (1.50 mm) to 0.315 (8.00 mm) greater than the overall component.
- (2) The given dimension "D" expresses the standard width spacing. A 26 mm narrow spacing is available as option "N" packaging code.

Ammo Packaging Specifications



Type/Code	Size	A	В	С	Unit
RNF	16		2.756 ± 0.118 70.00 ± 3.00		inches mm
RNF	14		3.937 ± 0.118 100.00 ± 3.00		inches mm
RNF	12	2.953 ± 0.079 75.00 ± 2.00	2.756 ± 0.118 70.00 ± 3.00	10.039 ± 0.197 255.00 ± 5.00	inches mm
RNF	1		2.953 ± 0.118 75.00 ± 3.00		inches mm
RNMF	14		2.756 ± 0.118 70.00 ± 3.00		inches mm
RNMF	12		3.937 ± 0.118 100.00 ± 3.00		inches mm

Pana-Sert Packaging Specifications



Symbol	Description	PRNF14	
ØD	Body diameter	0.102 max.	
95	Body diameter	2.60 max.	
^	Pody Jonath	0.276 max.	
A	Body length	7.00 max.	
A0	Mounting height	0.492 max.	
Au	Mounting height	12.50 max.	
Ød	Lead diameter	0.020 ± 0.002	
200	Lead diameter	0.52 ± 0.05	

Resistive Product Solutions

Packaging Specifications – Pana-Sert (cont.)						
Symbol	Description	PRNF14				
P	Component pitch	0.500 ± 0.039				
'	Component piter	12.70 ± 1.00				
P0	Feed hole pitch	0.500 ± 0.012				
	•	12.70 ± 0.30 0.152 ± 0.020				
P1	Feed hole center to lead	3.85 ± 0.50				
DO.	Foodbale contents hade	0.250 ± 0.016				
P2	Feed hole center to body	6.35 ± 0.40				
F	Lead-lead distance	0.200 +0.024 / -0.008				
'	Edd idd distance	5.08 +0.60 / -0.20				
Alpha	Performing angle	45° max.				
Δh	Component alignment	0.000 ± 0.079				
	Component anginiterit	0.00 ± 2.00				
Δg	Component alignment	0.000 ± 0.118 0.00 ± 3.00				
		0.00 ± 3.00 0.709 +0.039 / -0.031				
W	Tape width	18.00 +1.00 / -0.80				
1440		0.492 min.				
Wo	Hold down tape width	12.50 min.				
W1	Hole position	0.354 ± 0.020				
VVI	riole position	9.00 ± 0.50				
W2	Hold down tape position	0.079 +0 / -0.059				
		2.00 +0 / -1.5				
Н	Distance to tape center	0.748 ± 0.039 19.00 ± 1.00				
		0.630 ± 0.020				
H0	Lead wire clinch height	16.00 ± 0.50				
1	Load wire pertreit	0.039 max.				
	Lead wire portrait	1.00 max.				
ØD0	Feed hole diamenter	0.157 ± 0.008				
220	. 554 4.4	4.00 ± 0.20				
i	Total tape thickness	0.028 max.				
		0.70 max. 0.433 max.				
L	Length of shipped lead	0.433 max. 11.00 max.				
		i i.oo iiida.				

RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 2). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament.

	RoHS Compliance Status							
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)		
RNF	General Purpose Metal Film Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01		
RNMF	General Purpose Mini Metal Film Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01		

Stackpole Electronics, Inc.

General Purpose Metal Film Resistor

Resistive Product Solutions

"Conflict Metals" Commitment

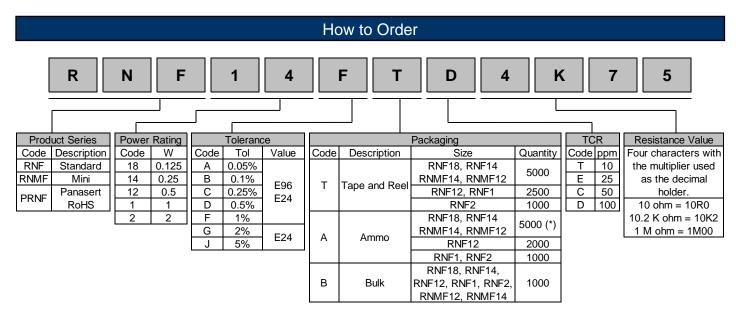
We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the Eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.



(*) Precision metal film resistors with tolerances <1% may be available in smaller quantities. Contact Stackpole for more details.